

COMMON PARTS/MATERIALS, SPACE USE,  
APPLICATION DATA SHEET FOR

Part Description	RESISTORS, CHIP, FIXED, METAL FILM
Part Number and Type	JAXA 2050/J401-1005 JAXA 2050/J401-1608 JAXA 2050/J401-2012 JAXA 2050/J401-3216 JAXA 2050/J401-3225
Applicable Specification	JAXA-QTS-2050D JAXA-QTS-2050/J401

October 2020

Prepared and Established by SANADA KOA Corporation

Issued by Japan Aerospace Exploration Agency

This document is the English version of JAXA QTS/ADS which was originally written and authorized in Japanese and carefully translated into English for international users. If any question arises as to the context or detailed description, it is strongly recommended to verify against the latest official Japanese version.

The release date of the English version of this specification: February 1, 2022

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Revision Log			
Rev.	Date	Description	
NC	24 Nov. 2010	Original.	
A	8 Jul. 2011	<p>Updated the result of characteristic test under various operating conditions with the requalification test performed.</p> <p>Updated the failure rate of qualified parts according to the increase of load life test samples.</p>	
B	23 Aug. 2019	<ol style="list-style-type: none"> <li>1. Updated the following test results in accordance with the requalification test performed. <ul style="list-style-type: none"> <li>• Updated the test results of dielectric withstand voltage, insulation resistance, and resistance-temperature characteristics for paragraph 4.1 Electrical Characteristics.</li> <li>• Updated the test results of Adhesion, board bending, resistance to board exposure, resistance to soldering heat, solderability, random vibration, shock, thermal shock [II], moisture resistance, resistance to solvents, and stability for paragraph 4.2 Mechanical and thermal characteristics.</li> <li>• Updated the test results of short-time overload and low-temperature operation for paragraph 5 Characteristics under various operating conditions.</li> </ul> </li> <li>2. Added the result of the acceleration test performed in life test during requalification test. <ul style="list-style-type: none"> <li>• Added the calculation condition and test results for paragraph 5 Characteristics under various operating conditions.</li> </ul> </li> <li>3. Updated the failure rate field data <ul style="list-style-type: none"> <li>• Updated paragraph 6.1.2 Failure Rate Field Data of General-Purpose Parts (Reference) to the current value.</li> </ul> </li> <li>4. Changed the company name from Tama Electric Co., Ltd. to SANADA KOA Corporation. <ul style="list-style-type: none"> <li>• Cover sheet: Prepared and Established by SANADA KOA Corporation</li> <li>• Paragraph 9: Manufacturer</li> </ul> </li> <li>5. P12: Corrected errors on the military specification number.</li> </ol>	
C	12 Oct. 2020	<ol style="list-style-type: none"> <li>1. Updated the following test results due to the requalification test except for omitted tests for styles 1005 and 1608. <ul style="list-style-type: none"> <li>• Paragraph 4.1 Electrical characteristics: Updated the test results for dielectric withstand voltage and insulation resistance.</li> <li>• Paragraph 4.2 Mechanical and thermal characteristics: Updated the test results for board bending, resistance to soldering heat, solderability, thermal shock (II), moisture resistance, resistance to solvents, and stability.</li> <li>• Paragraph 5 Characteristic under various operating conditions: Updated the test results for short-time overload and low temperature operation.</li> </ul> </li> <li>2. Clarified paragraph 8 NOTES: Clarified the description due to occurrence of peeled external electrode caused by the mishandling of the parts.</li> </ol>	

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**COMMON PARTS/MATERIALS,  
SPACE USE,  
APPLICATION DATA SHEET FOR**

## 1. GENERAL

### 1.1 Scope

This Application Data Sheet provides additional detailed information necessary for designing or selecting products not contained in JAXA QML. Relevant information not covered in this document shall also be considered. Users are responsible for all aspects pertaining to selection and use of the product(s) specified in this document.

### 1.2 Applicable Documents

JAXA -QTS-2050D	Resistors, High Reliability, Space Use, General Specification For
JAXA -QTS-2050/J401	Resistors, Chip, Fixed, Metal Film, High Reliability, Space Use, Detail Specification For

## 2. SUMMARY OF PRODUCT

### 2.1 Externals, Dimensions, Mass and Photograph

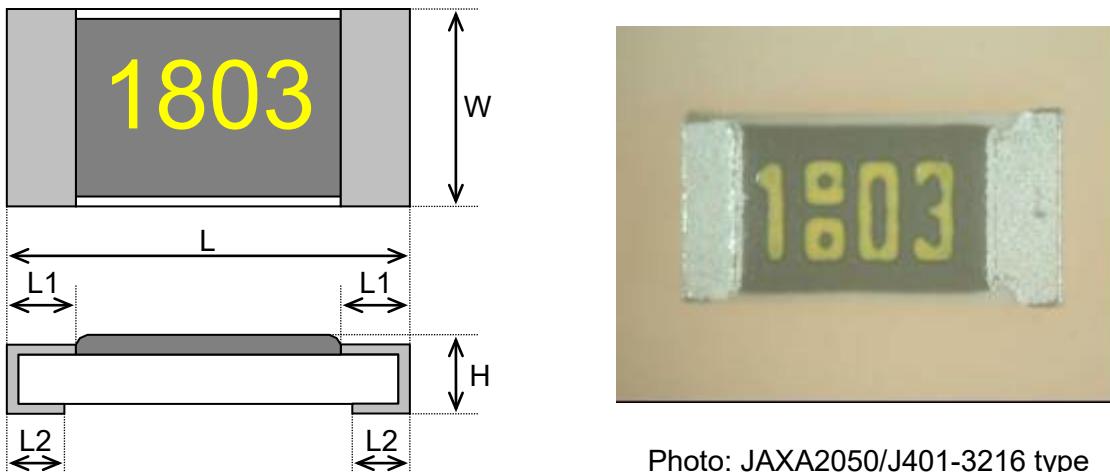
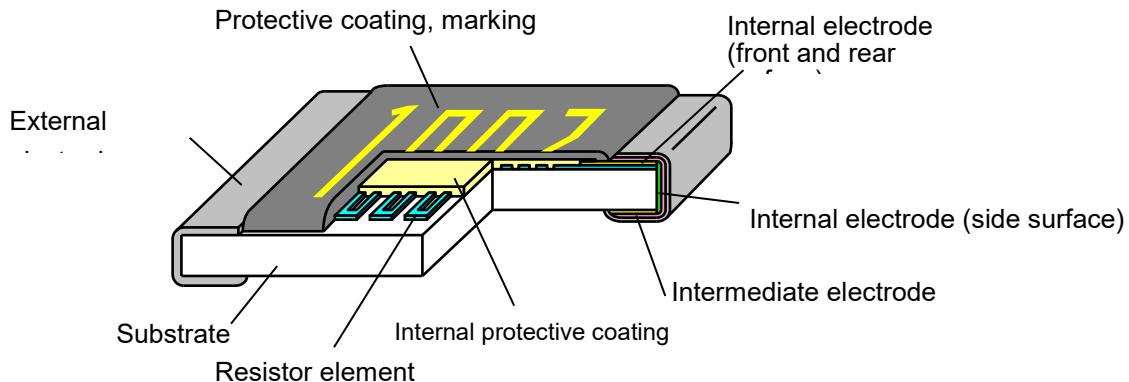


Photo: JAXA2050/J401-3216 type

Part name	Dimension [mm]					Mass (typ.value) [mg]
	L	W	H	L1	L2	
2050/J401-1005	1.0±0.1	0.5±0.05	0.35±0.05	0.2±0.1	0.25±0.1	0.68
2050/J401-1608	1.6±0.2	0.8±0.1	0.45±0.1	0.3±0.1	0.3±0.1	2.14
2050/J401-2012	2.0±0.2	1.25±0.2	0.5±0.1	0.4±0.2	0.3±0.1	4.54
2050/J401-3216	3.2 <sup>0.2</sup> <sub>0.3</sub>	1.6±0.2	0.6±0.1	0.5±0.3	0.4±0.2	9.14
2050/J401-3225	3.2 <sup>0.2</sup> <sub>0.3</sub>	2.5±0.2	0.6±0.1	0.5±0.3	0.4±0.2	14.5

## 2.2 Construction



Element	Main constituent
Substrate	96% alumina ( $\text{Al}_2\text{O}_3$ )
Internal electrode (front and rear surface)	Chromium, nickel, copper type (Cr, Ni, Cu)
Internal electrode (side surface)	Nickel chromium type (NiCr)
Resistor element	Nickel chromium type (NiCr)
Internal protective coating	Inorganic type
Protective coating, marking	Epoxy type
Intermediate electrode	Nickel plating (Ni)
External electrode	Solder plating (Sn90-Pb10)

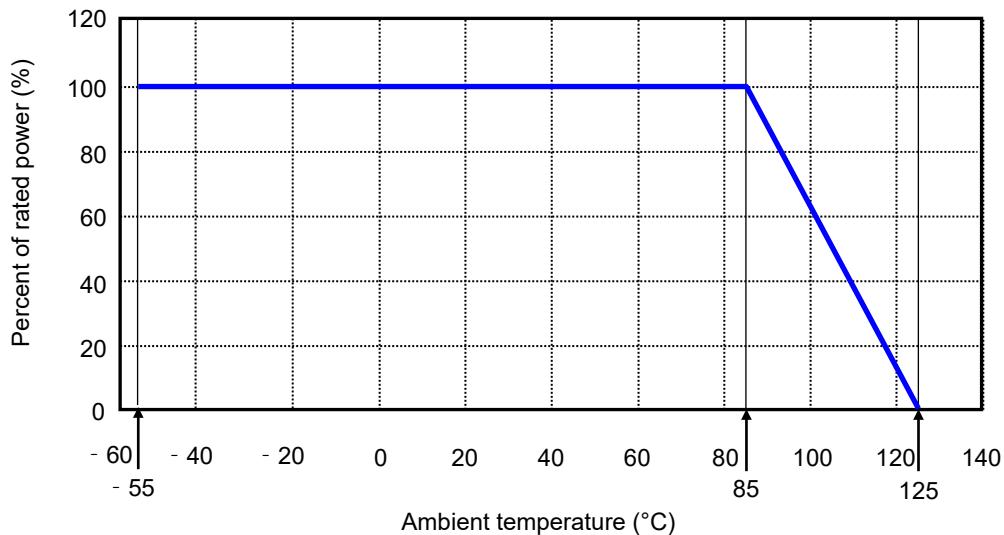
## 3. USAGE

## 3.1 Absolute Maximum Ratings

Item	2050/J401 -1005	2050/J401 -1608	2050/J401 -2012	2050/J401 -3216	2050/J401 -3225
Operating temperature range (°C)		-55 to +125			
Rated ambient temperature (°C)		85			
Nominal resistance range (Ω)		10 to 510k (see Appended Table) <sup>(2)</sup>			
Critical resistance (Ω)	76.8k	—	100k	180k	160k
Maximum operating voltage (V)	50	75	100	150	200
Maximum overload voltage (V)	75	150	200	300	400
Rated power (W) <sup>(1)</sup>	0.032	0.05	0.10	0.125	0.25

Notes: <sup>(1)</sup> If the temperature exceeds rated ambient temperature, load power shall be derated in accordance with the derating curve in Figure 1.

<sup>(2)</sup> The range of nominal resistance differs according to the style, resistance tolerance and resistance-temperature characteristics.



**Figure 1. Derating Curve**

### 3.2 Recommended Operating Conditions

It is recommended to operate the resistors at 50% or less of the rated power specified in the derating curve shown in Figure 1.

### 3.3 Notes for Circuit Design

If the rated calculated voltage exceeds the maximum operating voltage, the maximum operating voltage shall be used as the rated voltage.

$$E = \sqrt{P \times R}$$

E: Rated voltage (V)  
P: Rated power (W)  
R: Nominal resistance ( $\Omega$ )

### 3.4 Recommended Mounting Method

Solder: Sn/Pb eutectic solder (melting-point temperature: 183°C)

Flux: Less corrosive rosin flux (when applied)

Mounting method	Soldering conditions
Reflow	Preheating: 150°C, 60 sec max. Soldering: 240±5°C, 6 sec max. Frequency: 2 times max.
Flow	Soldering: 260±10°C, 10 sec max. Frequency: 1 times only
Hand soldering	Soldering: 350±10°C, 3 sec max. Soldering iron shall be 20W max or temperature controllable.

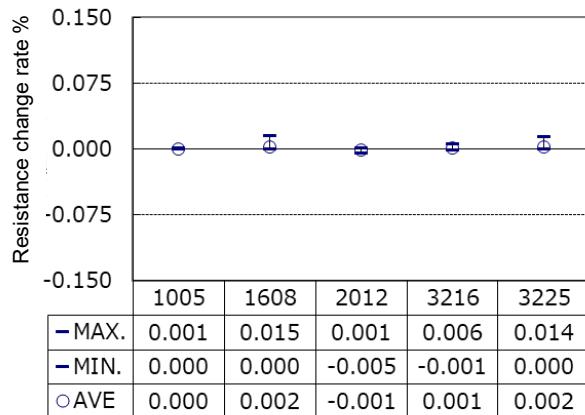
### 3.5 Cleansing

Cleansing shall be performed by immersing the resistor in alcohols (non-chlorinated) solvents for a maximum of 5 minutes.

## 4. CHARACTERISTICS UNDER NORMAL OPERATING CONDITIONS

### 4.1 Electrical Characteristics

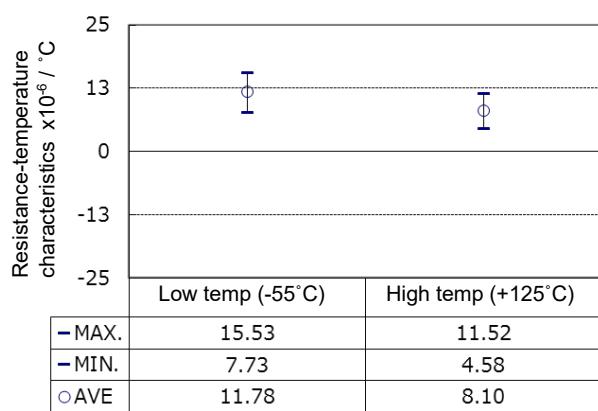
Dielectric withstanding voltage  
(atmospheric pressure) n=10  
A.C. 150Vrms-60sec  
Limit:  $\pm (0.15\%+0.01\Omega)$



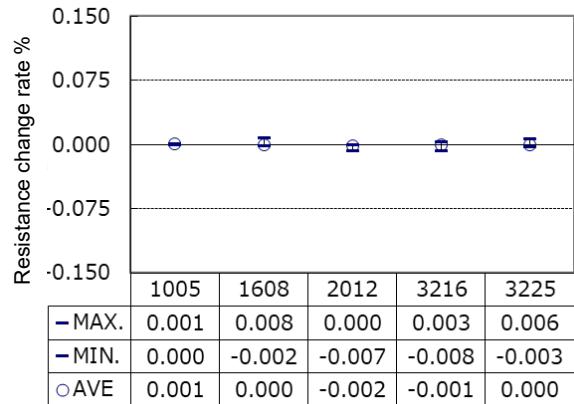
Insulation resistance n=10  
Condition: D.C. 100V-60sec  
Limit:  $10^3 M\Omega$  min.

Style	Result
J2050/J401-1005	More than $10G\Omega$ for all samples
J2050/J401-1608	More than $10G\Omega$ for all samples
J2050/J401-2012	More than $10G\Omega$ for all samples
J2050/J401-3216	More than $10G\Omega$ for all samples
J2050/J401-3225	More than $10G\Omega$ for all samples

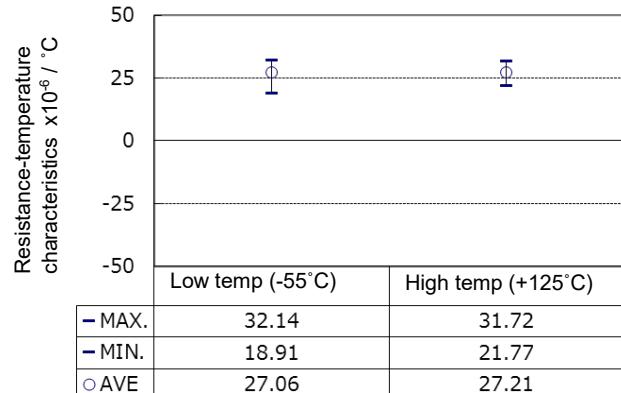
Resistance-temperature characteristics n=10  
Condition: -55°C/25°C/125°C  
Limit:  $\pm 25 \times 10^{-6} / ^\circ C$   
J2050/J401-1005E7682B



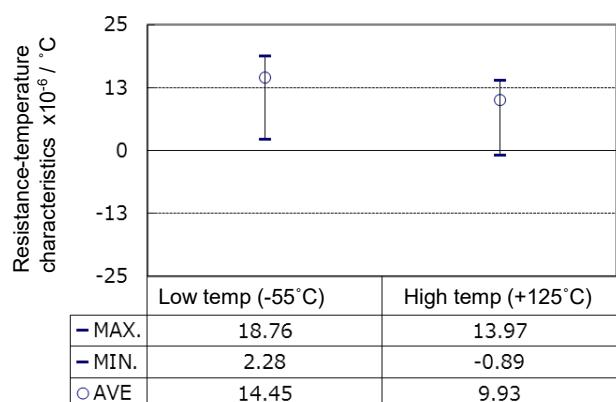
Dielectric withstanding voltage  
(reduced pressure) n=10  
A.C. 75Vrms-60sec  
Limit:  $\pm (0.15\%+0.01\Omega)$



Resistance-temperature characteristics n=10  
Condition: -55°C/25°C/125°C  
Limit:  $\pm 50 \times 10^{-6} / ^\circ C$   
J2050/J401-1005H10R0D



Resistance-temperature characteristics n=10  
Condition: -55°C/25°C/125°C  
Limit:  $\pm 25 \times 10^{-6} / ^\circ C$   
J2050/J401-1005E1003B

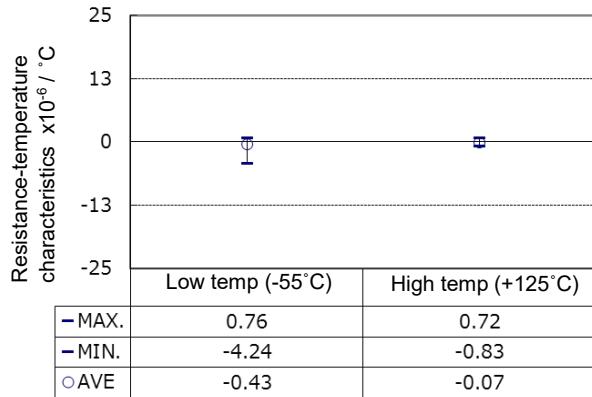


Resistance-temperature characteristics n=10

Condition: -55°C/25°C/125°C

Limit:  $\pm 25 \times 10^{-6} / ^\circ C$

J2050/J401-1005E51R0D

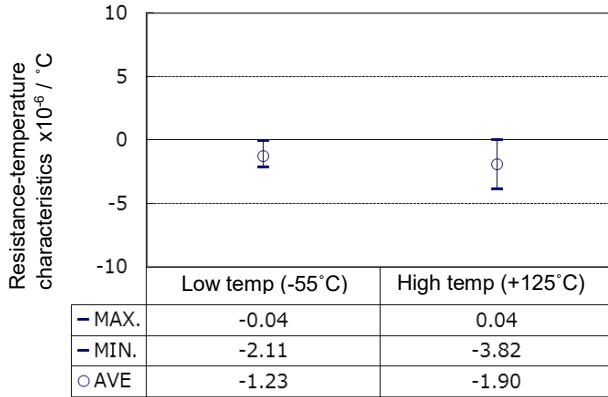


Resistance-temperature characteristics n=10

Condition: -55°C/25°C/125°C

Limit:  $\pm 10 \times 10^{-6} / ^\circ C$

J2050/J401-1005Y1000B

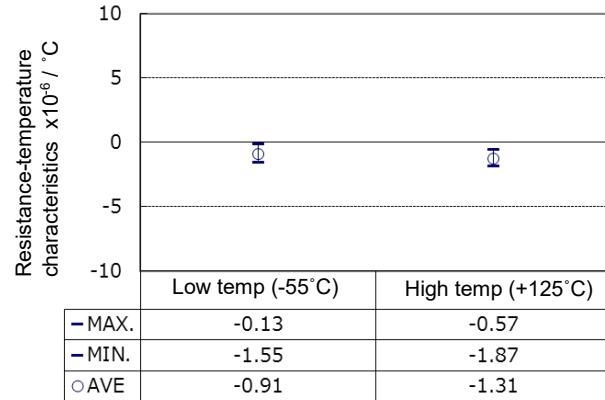


Resistance-temperature characteristics n=10

Condition: -55°C/25°C/125°C

Limit:  $\pm 10 \times 10^{-6} / ^\circ C$

J2050/J401-1005Y1002B

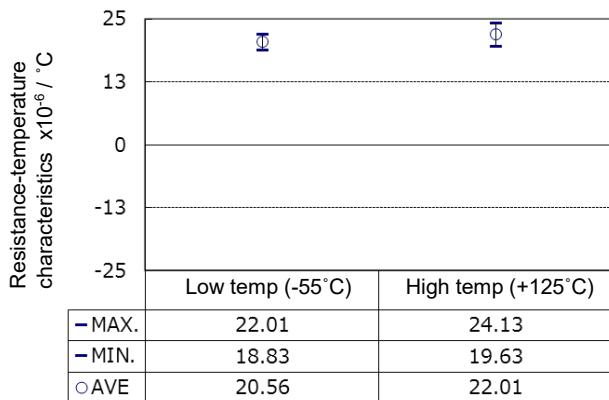


Resistance-temperature characteristics n=15

Condition: -55°C/25°C/125°C

Limit:  $\pm 25 \times 10^{-6} / ^\circ C$

J2050/J401-1608E10R0D

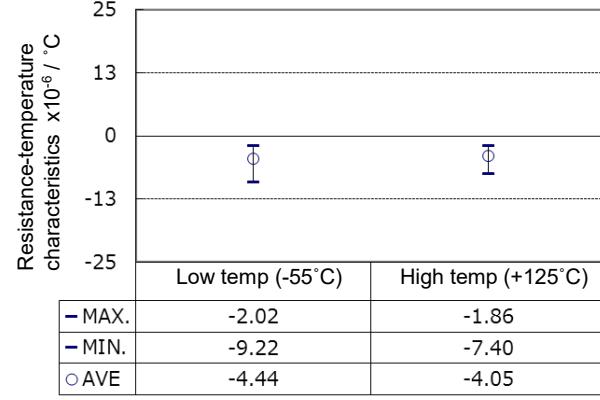


Resistance-temperature characteristics n=15

Condition: -55°C/25°C/125°C

Limit:  $\pm 25 \times 10^{-6} / ^\circ C$

J2050/J401-1608E5902B

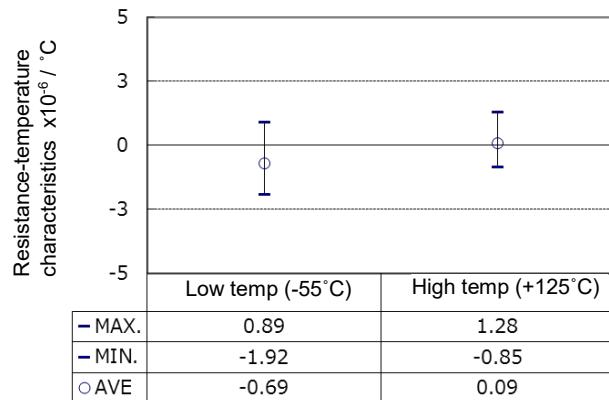


Resistance-temperature characteristics n=10

Condition: -55°C/25°C/125°C

Limit:  $\pm 5 \times 10^{-6} / ^\circ C$

J2050/J401-1608A1000B

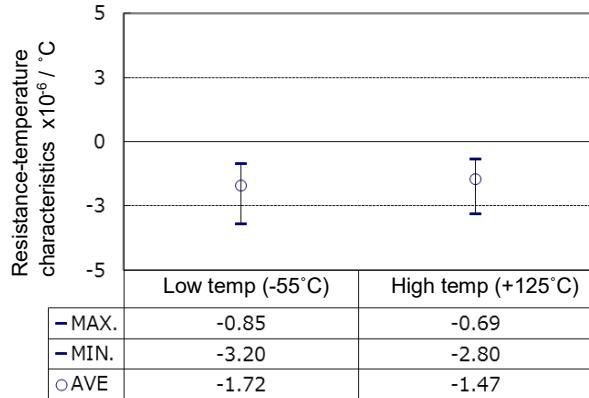


Resistance-temperature characteristics n=10

Condition: -55°C/25°C/125°C

Limit:  $\pm 5 \times 10^{-6} / ^\circ C$

J2050/J401-1608A4702B

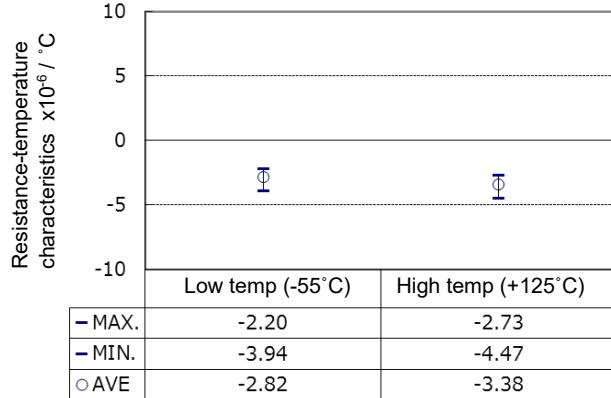


Resistance-temperature characteristics n=10

Condition: -55°C/25°C/125°C

Limit:  $\pm 10 \times 10^{-6} / ^\circ C$

J2050/J401-1608Y5902B

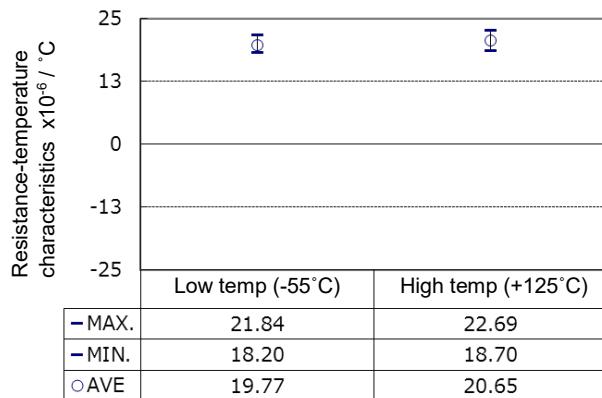


Resistance-temperature characteristics n=15

Condition: -55°C/25°C/125°C

Limit:  $\pm 25 \times 10^{-6} / ^\circ C$

J2050/J401-2012E10R0D

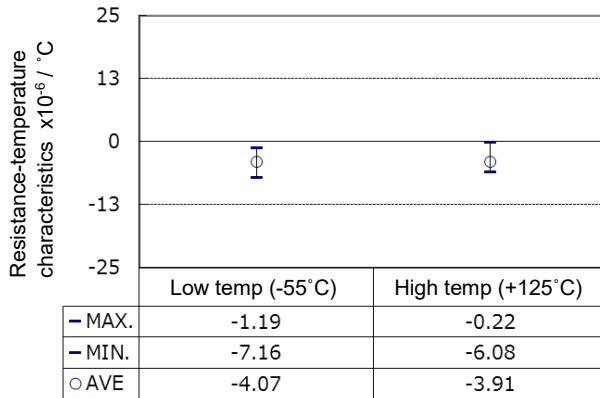


Resistance-temperature characteristics n=15

Condition: -55°C/25°C/125°C

Limit:  $\pm 25 \times 10^{-6} / ^\circ C$

J2050/J401-2012E1003B

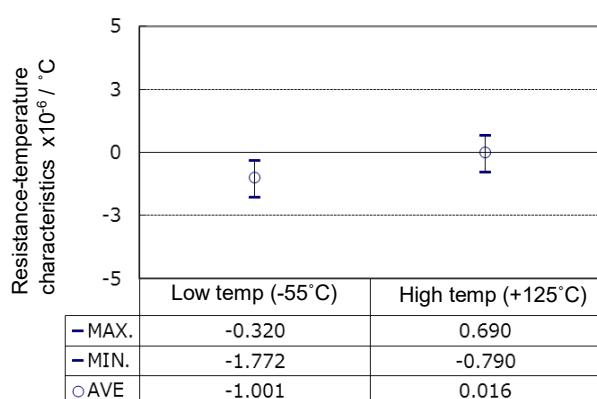


Resistance-temperature characteristics n=15

Condition: -55°C/25°C/125°C

Limit:  $\pm 5 \times 10^{-6} / ^\circ C$

J2050/J401-2012A1000B

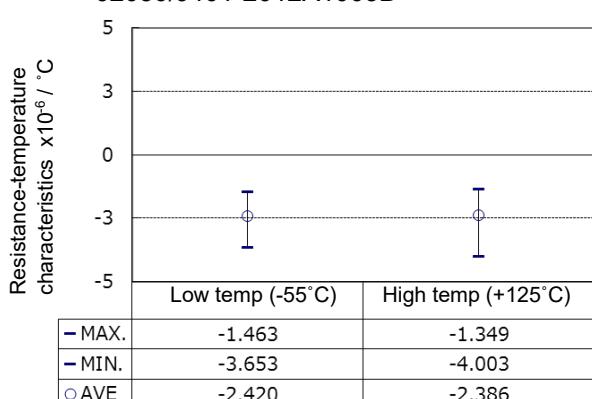


Resistance-temperature characteristics n=15

Condition: -55°C/25°C/125°C

Limit:  $\pm 5 \times 10^{-6} / ^\circ C$

J2050/J401-2012A1003B

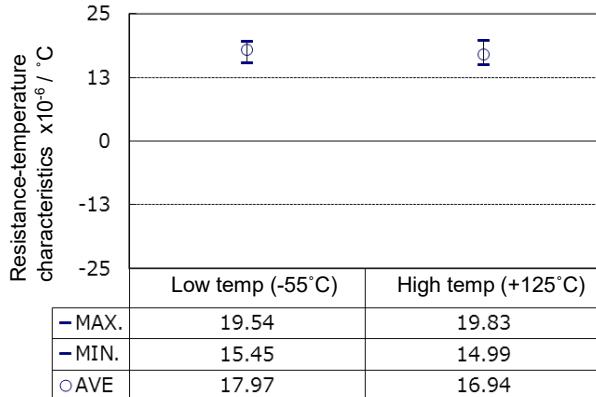


Resistance-temperature characteristics n=10

Condition: -55°C/25°C/125°C

Limit:  $\pm 25 \times 10^{-6} / ^\circ C$

J2050/J401-3216E10R0D

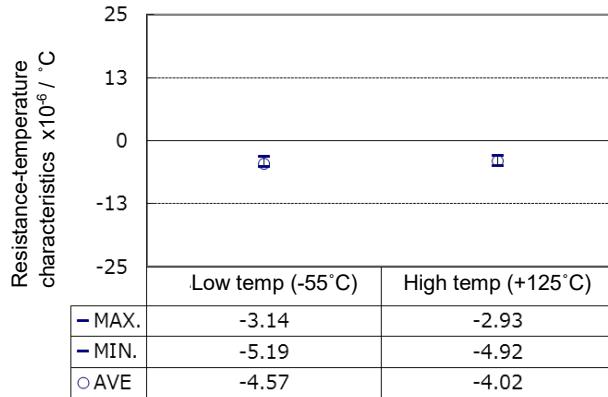


Resistance-temperature characteristics n=10

Condition: -55°C/25°C/125°C

Limit:  $\pm 25 \times 10^{-6} / ^\circ C$

J2050/J401-3216E1803B

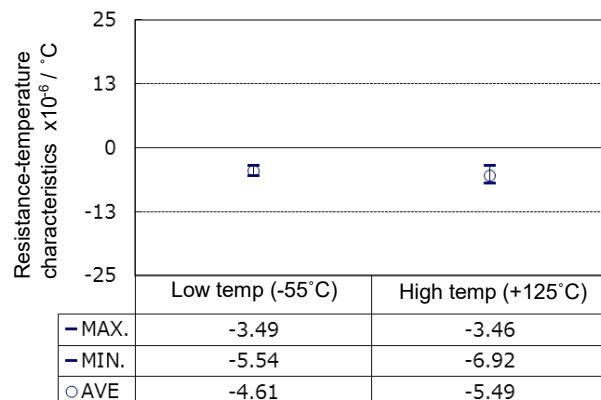


Resistance-temperature characteristics n=10

Condition: -55°C/25°C/125°C

Limit:  $\pm 25 \times 10^{-6} / ^\circ C$

J2050/J401-3216E3003B

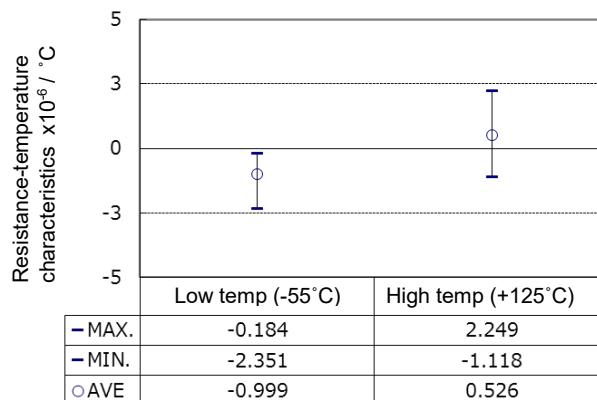


Resistance-temperature characteristics n=15

Condition: -55°C/25°C/125°C

Limit:  $\pm 5 \times 10^{-6} / ^\circ C$

J2050/J401-3216A1000B

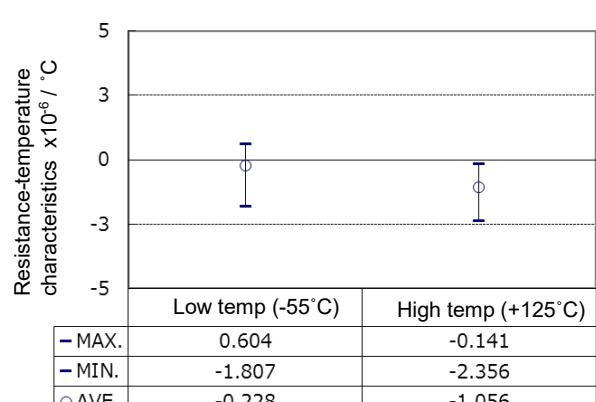


Resistance-temperature characteristics n=15

Condition: -55°C/25°C/125°C

Limit:  $\pm 5 \times 10^{-6} / ^\circ C$

J2050/J401-3216A3003B

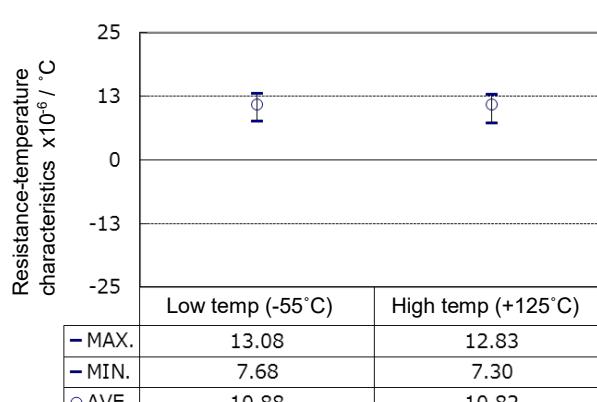


Resistance-temperature characteristics n=10

Condition: -55°C/25°C/125°C

Limit:  $\pm 25 \times 10^{-6} / ^\circ C$

J2050/J401-3225E10R0D

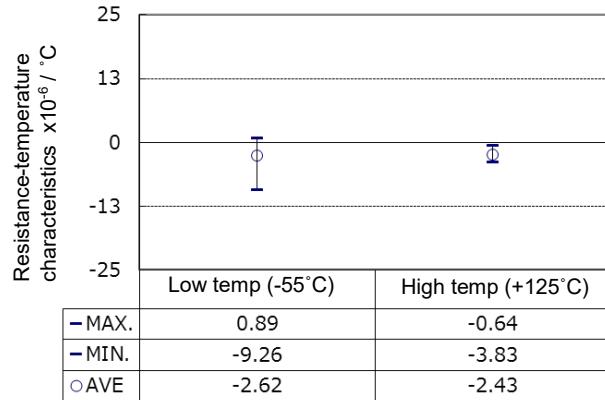


Resistance-temperature characteristics n=10

Condition: -55°C/25°C/125°C

Limit:  $\pm 25 \times 10^{-6} / ^\circ C$

J2050/J401-3225E1603B

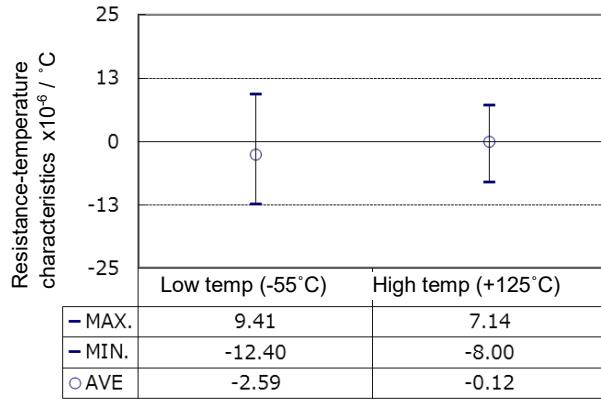


Resistance-temperature characteristics n=10

Condition: -55°C/25°C/125°C

Limit:  $\pm 25 \times 10^{-6} / ^\circ C$

J2050/J401-3225E5103B

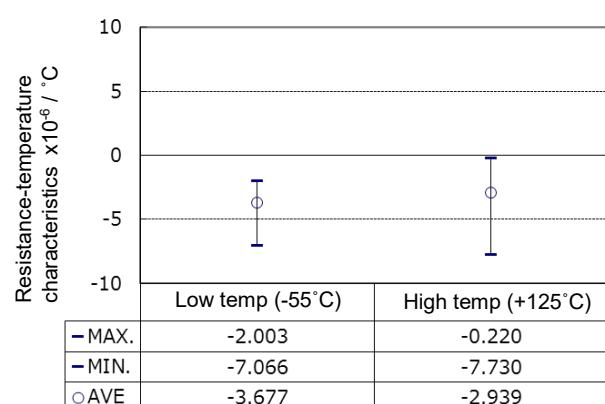


Resistance-temperature characteristics n=15

Condition: -55°C/25°C/125°C

Limit:  $\pm 10 \times 10^{-6} / ^\circ C$

J2050/J401-3225Y1000B

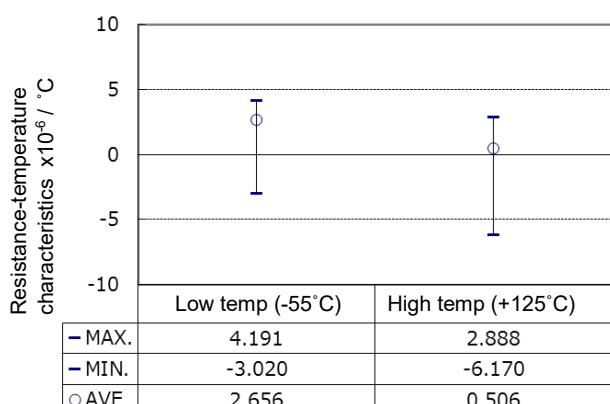


Resistance-temperature characteristics n=15

Condition: -55°C/25°C/125°C

Limit:  $\pm 10 \times 10^{-6} / ^\circ C$

J2050/J401-3225Y5103B



## 4.2 Mechanical and Thermal Characteristics

Adhesion n=10

Condition: 5N-10sec

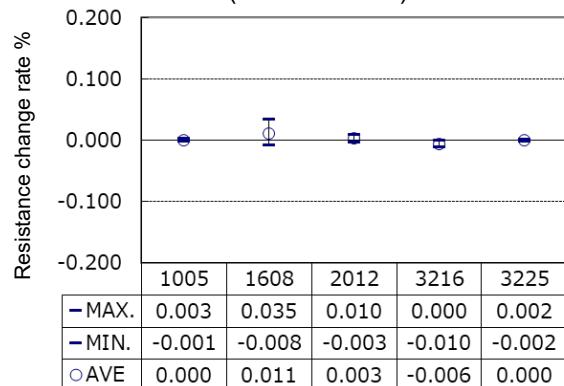
Acceptance criteria: There shall be no damage.

Style	Test result
J2050/J401-1005	No damage
J2050/J401-1608	No damage
J2050/J401-2012	No damage
J2050/J401-3216	No damage
J2050/J401-3225	No damage

Board bending n=10

Condition: Flexure 2mm

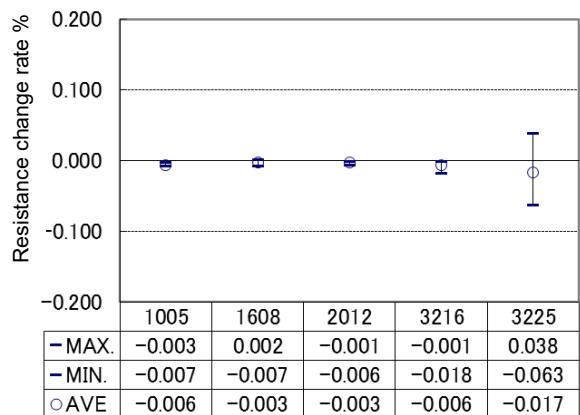
Limit:  $\pm (0.20\%+0.01\Omega)$



Resistance to bonding exposure n=10

Condition: 260°C-10sec → left for 4 to 12hr

Limit:  $\pm (0.20\%+0.01\Omega)$

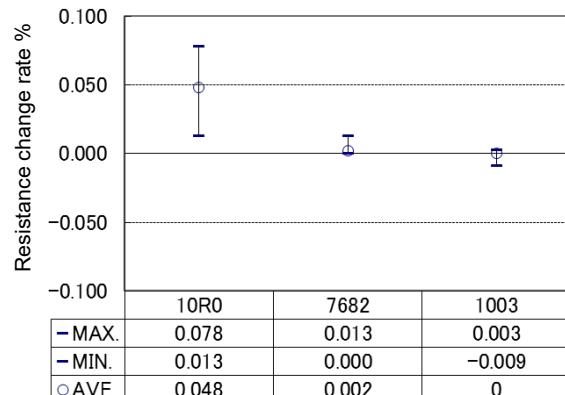


Resistance to soldering heat n=10

Condition: 260°C-10sec

Limit:  $\pm (0.10\%+0.01\Omega)$

J2050/J401-1005

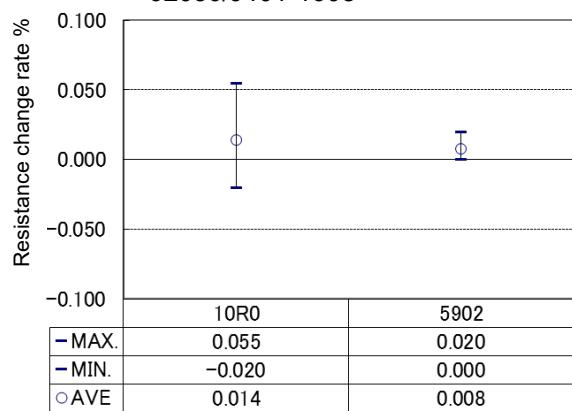


Resistance to soldering heat n=15

Condition: 260°C-10sec

Limit:  $\pm (0.10\%+0.01\Omega)$

J2050/J401-1608

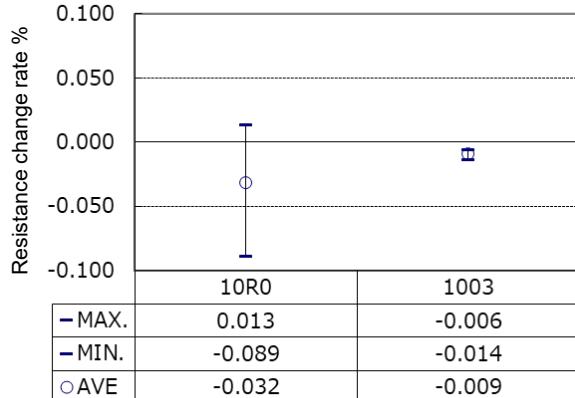


Resistance to soldering heat n=15

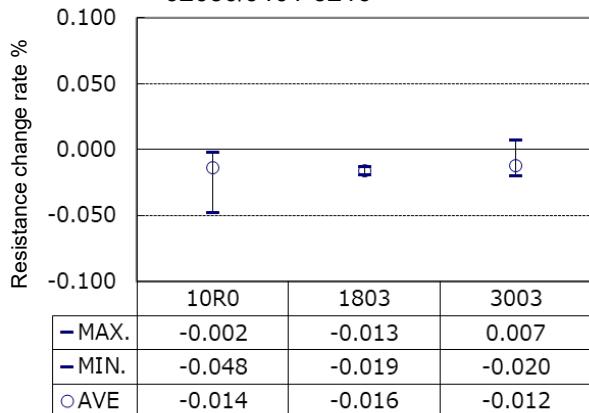
Condition: 260°C-10sec

Limit:  $\pm (0.10\%+0.01\Omega)$

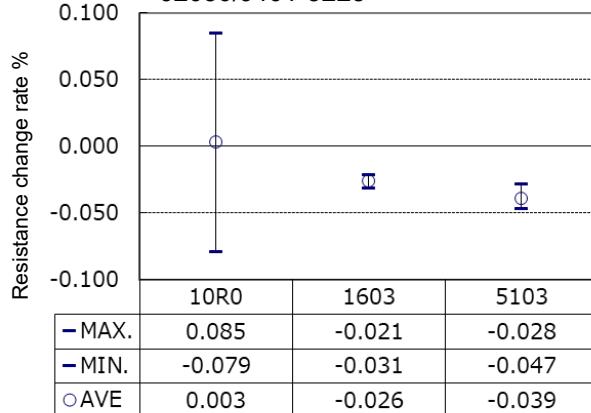
J2050/J401-2012



Resistance to soldering heat n=10  
Condition: 260°C-10sec  
Limit:  $\pm (0.10\% + 0.01\Omega)$   
J2050/J401-3216



Resistance to soldering heat n=10  
Condition: 260°C-10sec  
Limit:  $\pm (0.10\% + 0.01\Omega)$   
J2050/J401-3225



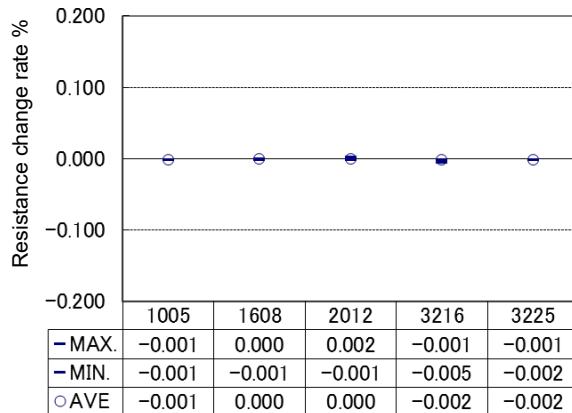
Solderability n=10  
Condition: 245°C-5sec  
Acceptance criteria: 95% min.

	Test result
J2050/J401-1005	More than 95% for all samples
J2050/J401-1608	More than 95% for all samples
J2050/J401-2012	More than 95% for all samples
J2050/J401-3216	More than 95% for all samples
J2050/J401-3225	More than 95% for all samples

Random vibration n=10

Condition: 50 to 2000Hz, 334m/s<sup>2</sup>,  
3 min each for XYZ axes

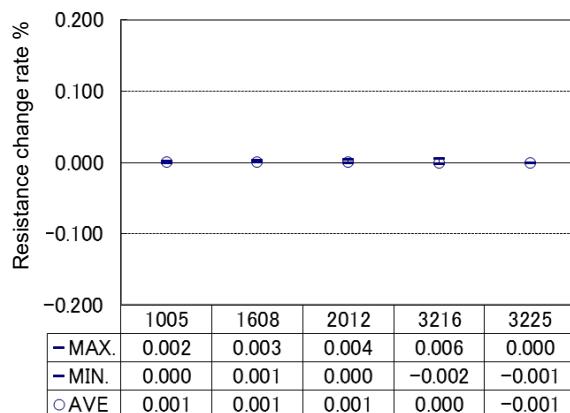
Limit:  $\pm (0.20\%+0.01\Omega)$



Shock n=10

Condition: 980m/s<sup>2</sup>, 6rms sawtooth wave  
5 times each for XYZ axes

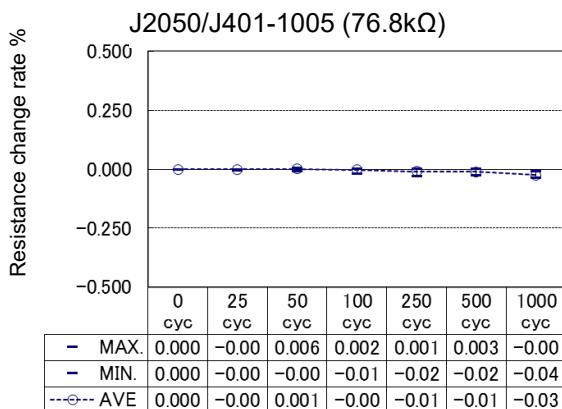
Limit:  $\pm (0.20\%+0.01\Omega)$



Thermal shock [II] n=10

Condition: -30°C(15min)/+25°C(5min)/100°C  
(15min)/+25°C(5min), 1000cycle

Limit:  $\pm (0.50\%+0.01\Omega)$

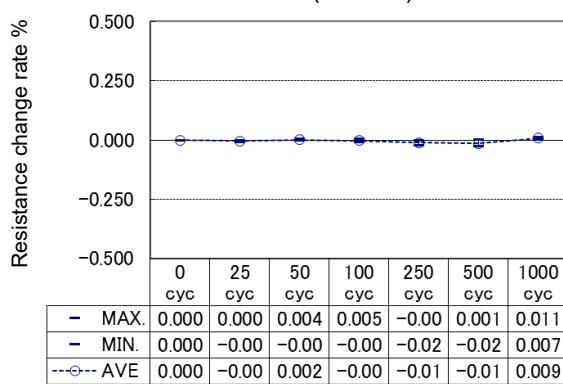


Thermal shock [II] n=10

Condition: -30°C(15min)/+25°C(5min)/100°C  
(15min)/+25°C(5min), 1000cycle

Limit:  $\pm (0.50\%+0.01\Omega)$

J2050/J401-1608 (59.0kΩ)

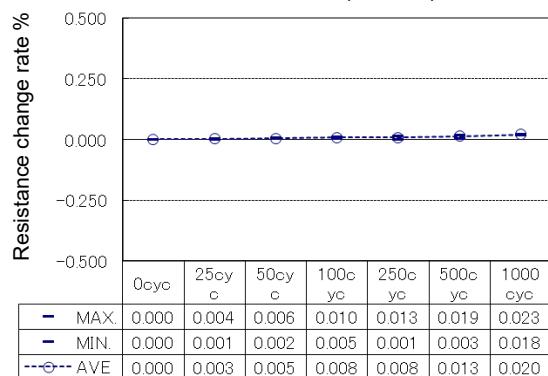


Thermal shock [II] n=10

Condition: -30°C(15min)/+25°C(5min)/100°C  
(15min)/+25°C(5min), 1000cycle

Limit:  $\pm (0.50\%+0.01\Omega)$

J2050/J401-2012 (100kΩ)

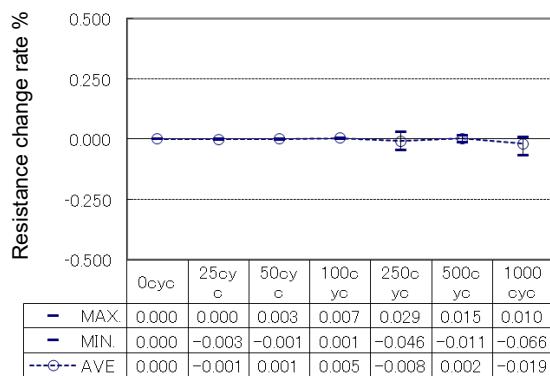


Thermal shock [II] n=10

Condition: -30°C(15min)/+25°C(5min)/100°C  
(15min)/+25°C(5min), 1000cycle

Limit:  $\pm (0.50\%+0.01\Omega)$

J2050/J401-3216 (180kΩ)

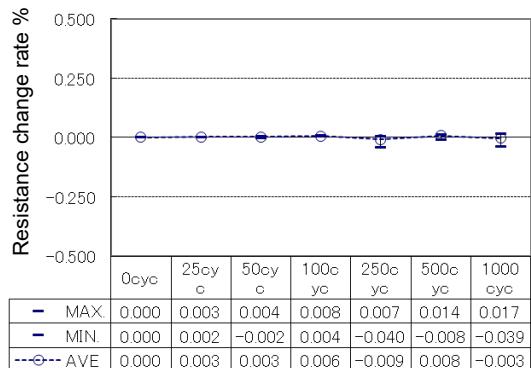


Thermal shock [II] n=10

Condition: -30°C(15min)/+25°C(5min)/100°C  
(15min)/+25°C(5min), 1000cycle

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-3225 (160k $\Omega$ )

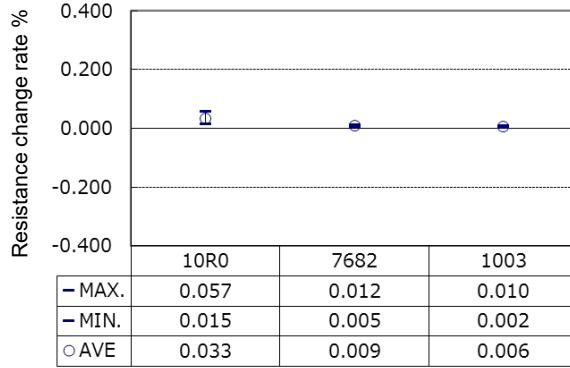


Moisture resistance n=10

Condition: MIL-STD-202, Method 106<sup>(3)</sup>

Limit:  $\pm (0.40\% + 0.01\Omega)$

J2050/J401-1005

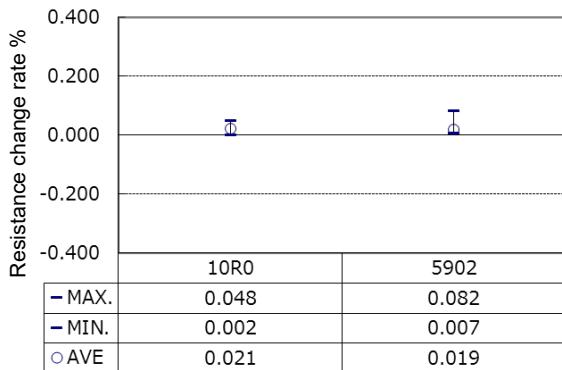


Moisture resistance n=15

Condition: MIL-STD-202, Method 106<sup>(3)</sup>

Limit:  $\pm (0.40\% + 0.01\Omega)$

J2050/J401-1608

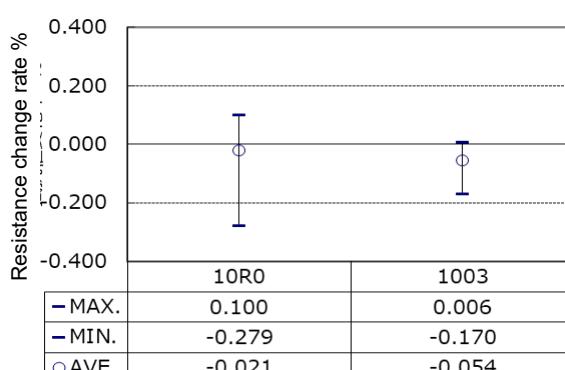


Moisture resistance n=15

Condition: MIL-STD-202, Method 106<sup>(3)</sup>

Limit:  $\pm (0.40\% + 0.01\Omega)$

J2050/J401-2012

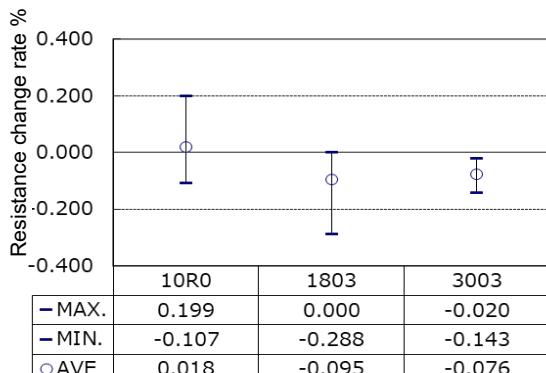


Moisture resistance n=10

Condition: MIL-STD-202, Method 106<sup>(3)</sup>

Limit:  $\pm (0.40\% + 0.01\Omega)$

J2050/J401-3216

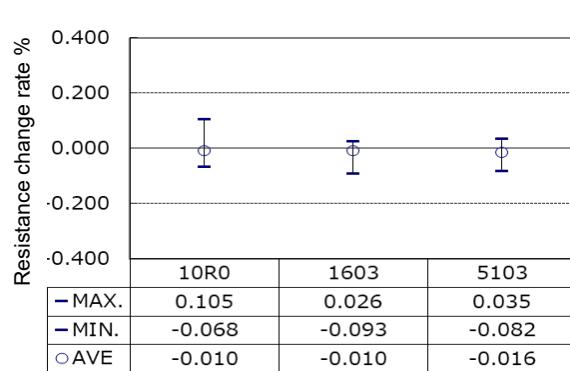


Moisture resistance n=10

Condition: MIL-STD-202, Method 106<sup>(3)</sup>

Limit:  $\pm (0.40\% + 0.01\Omega)$

J2050/J401-3225



Note <sup>(3)</sup>: The subcycle of step 7b and loading voltage are not applicable. The subcycle of step 7a applies the first 5 cycles.

Resistance to solvents n=10

Condition 1: 2-propanol

Condition 2: Water (42 parts by volume),  
propylene glycol methyl ether (1 part),  
monoethanolamine (1 part)

Acceptance criteria: There shall be no damage.  
Marking shall be clearly legible.

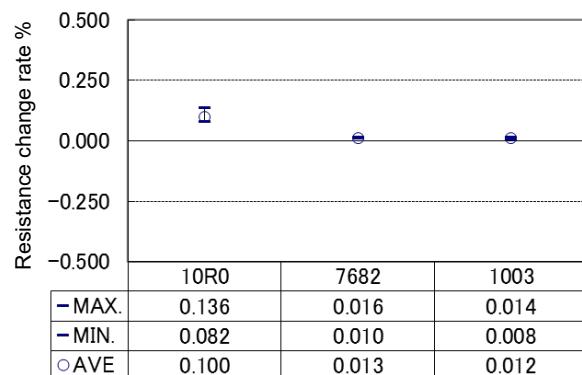
	Condition 1	Condition 2
J2050/J401-1005	No defect	No defect
J2050/J401-1608	No defect	No defect
J2050/J401-2012	No defect	No defect
J2050/J401-3216	No defect	No defect
J2050/J401-3225	No defect	No defect

Stability n=10

Condition: 125°C-without load, 2000H

Limit:  $\pm (0.50\%+0.01\Omega)$

J2050/J401-1005

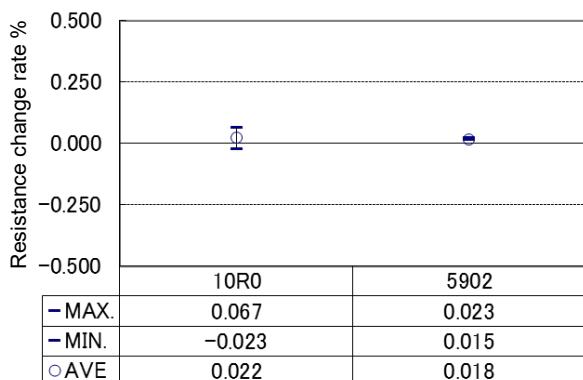


Stability n=15

Condition: 125°C-without load, 2000H

Limit:  $\pm (0.50\%+0.01\Omega)$

J2050/J401-1608

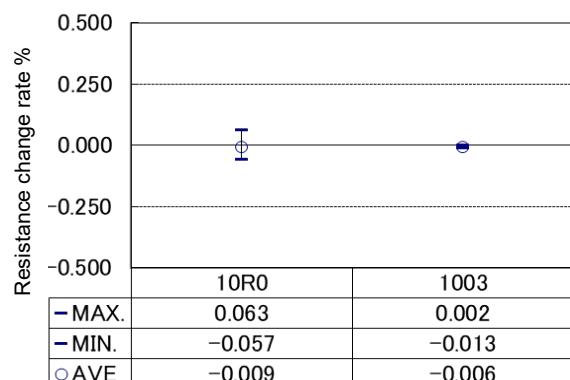


Stability n=15

Condition: 125°C-without load, 2000H

Limit:  $\pm (0.50\%+0.01\Omega)$

J2050/J401-2012

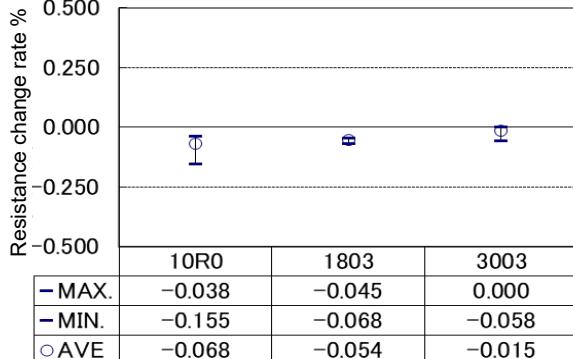


Stability n=10

Condition: 125°C-without load, 2000H

Limit:  $\pm (0.50\%+0.01\Omega)$

J2050/J401-3216

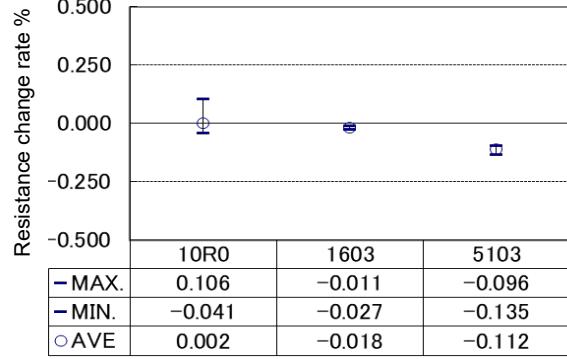


Stability n=10

Condition: 125°C-without load, 2000H

Limit:  $\pm (0.50\%+0.01\Omega)$

J2050/J401-3225



#### 4.3 Outgassing

Outgassing test result of protective coating (epoxy type)

Item	Requirement	Measurement result (%)
Total Mass Loss (TML)	1.0% max.	0.368 to 0.410
Collectable Volatile Condensable Materials (CVCM)	0.1% max.	0.001 to 0.002
Water Vapor Regained (WVR)	-	0.215 to 0.230

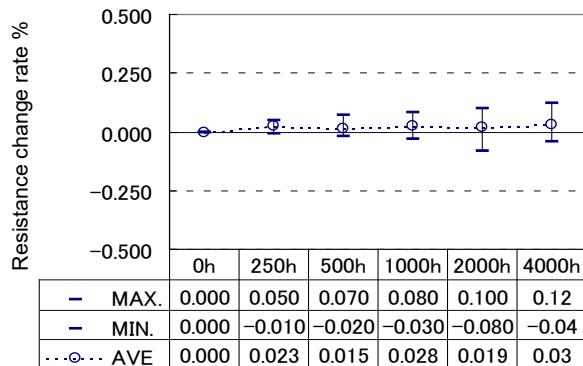
## 5. CHARACTERISTIC UNDER VARIOUS OPERATING CONDITIONS

Life n=77

Condition: 85°C-rated voltage, 4000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-1005 (10.0Ω)

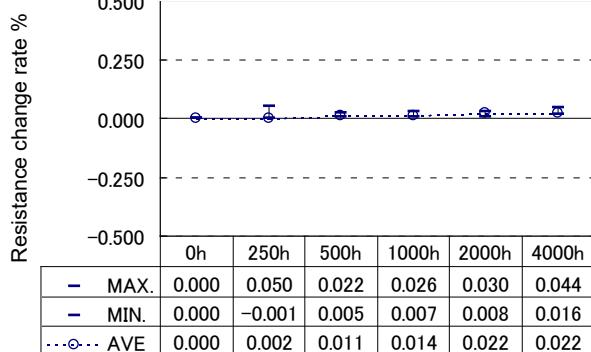


Life n=77

Condition: 85°C- rated voltage, 4000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-1005 (76.8kΩ)

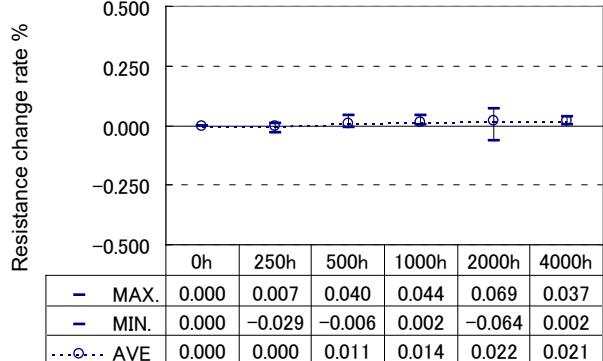


Life n=77

Condition: 85°C-rated voltage, 4000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-1005 (100kΩ)

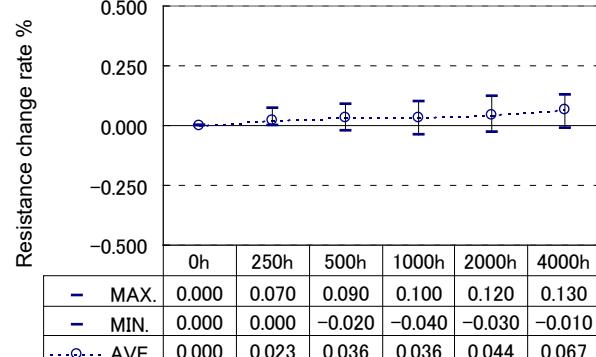


Life n=116

Condition: 85°C- rated voltage, 4000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-1608 (10.0Ω)

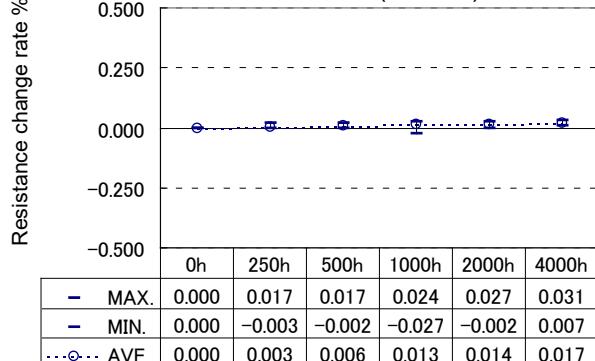


Life n=116

Condition: 85°C-rated voltage, 4000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-1608 (59.0kΩ)

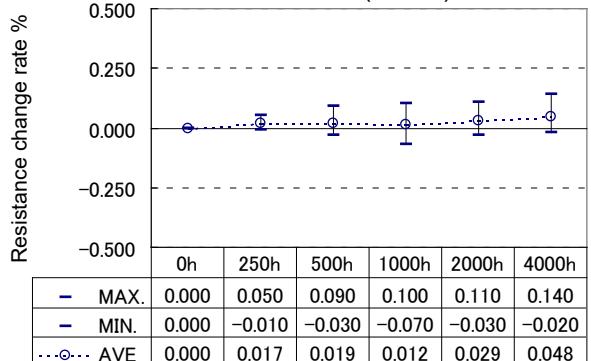


Life n=116

Condition: 85°C- rated voltage, 4000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-2012 (10.0Ω)

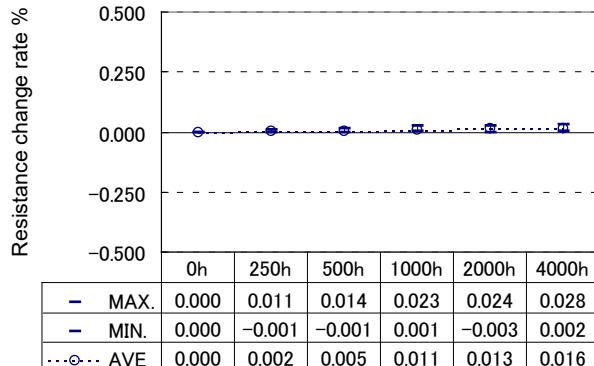


Life n=116

Condition: 85°C-rated voltage, 4000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-2012 (100k $\Omega$ )

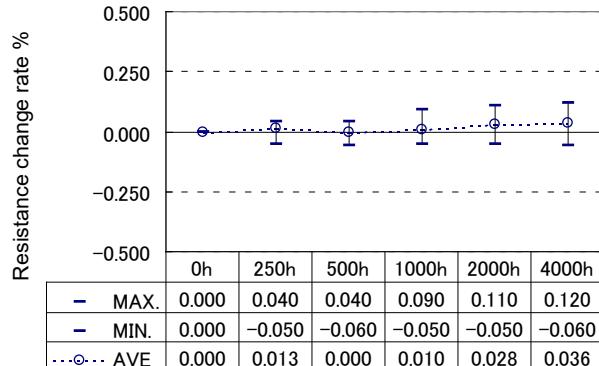


Life n=77

Condition: 85°C- rated voltage, 4000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-3216 (10.0 $\Omega$ )

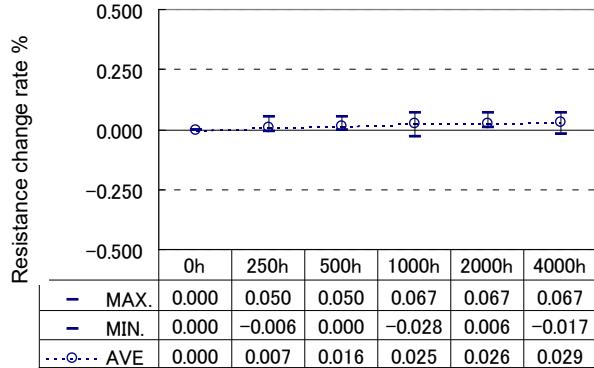


Life n=77

Condition: 85°C-rated voltage, 4000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-3216 (180k $\Omega$ )

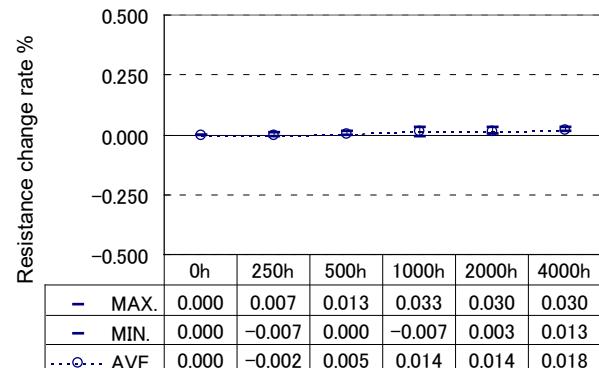


Life n=77

Condition: 85°C- rated voltage, 4000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-3216 (300k $\Omega$ )

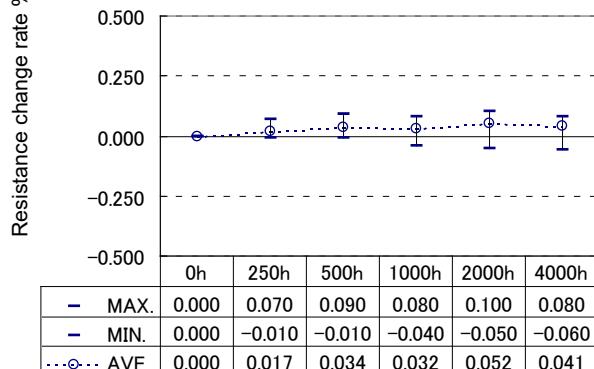


Life n=77

Condition: 85°C-rated voltage, 4000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-3225 (10.0k $\Omega$ )

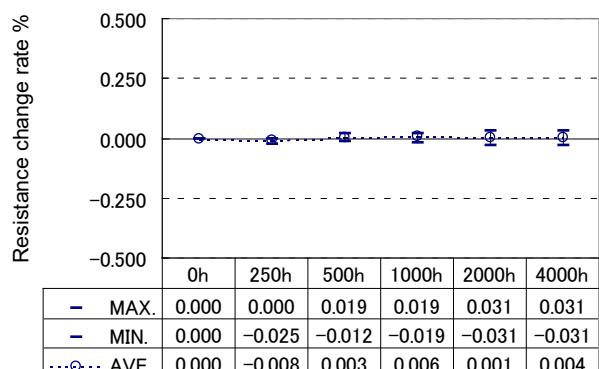


Life n=77

Condition: 85°C- rated voltage, 4000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-3225 (160k $\Omega$ )

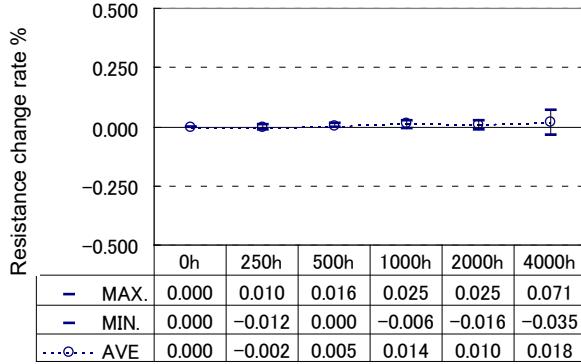


Life n=77

Condition: 85°C-rated voltage, 4000H

Limit:  $\pm (0.50\%+0.01\Omega)$

J2050/J401-3225 (510kΩ)

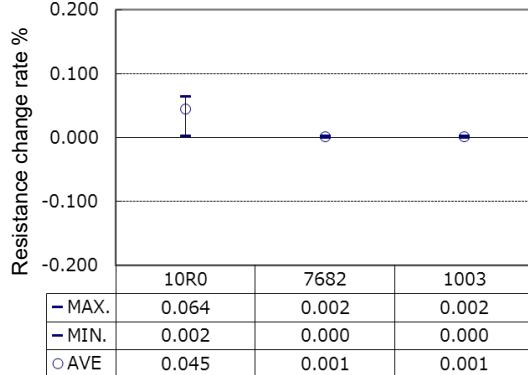


Short-time overload n=10

Condition: Rated voltage x 2.5-5sec

Limit:  $\pm (0.20\%+0.01\Omega)$

J2050/J401-1005

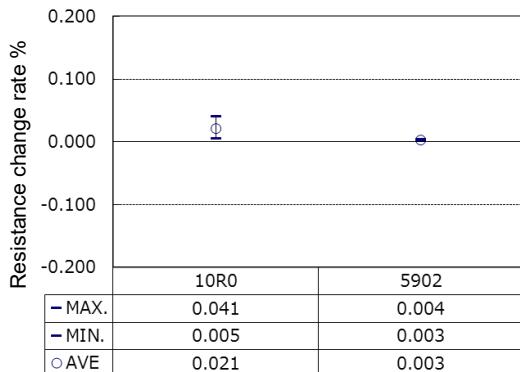


Short-time overload n=15

Condition: Rated voltage x 2.5-5sec

Limit:  $\pm (0.20\%+0.01\Omega)$

J2050/J401-1608

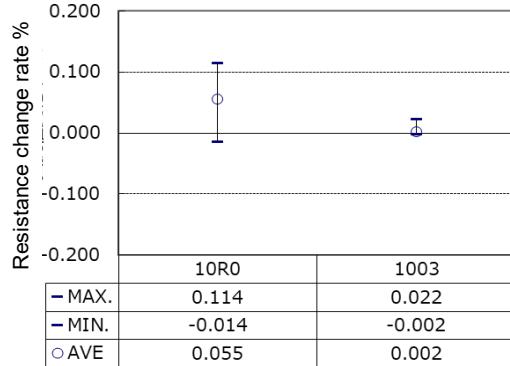


Short-time overload n=15

Condition: Rated voltage x 2.5-5sec

Limit:  $\pm (0.20\%+0.01\Omega)$

J2050/J401-2012

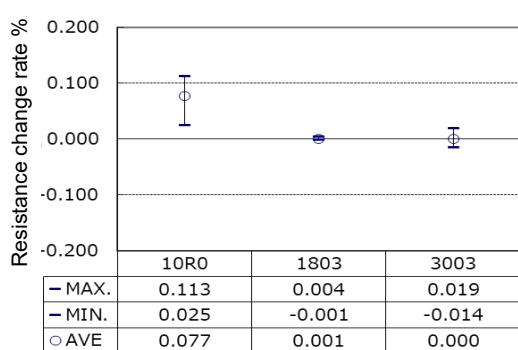


Short-time overload n=10

Condition: Rated voltage x 2.5-5sec

Limit:  $\pm (0.20\%+0.01\Omega)$

J2050/J401-3216

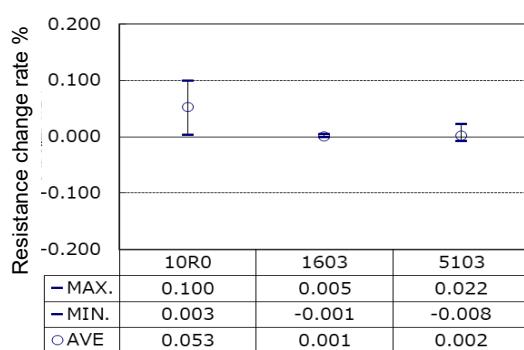


Short-time overload n=10

Condition: Rated voltage x 2.5-5sec

Limit:  $\pm (0.20\%+0.01\Omega)$

J2050/J401-3225

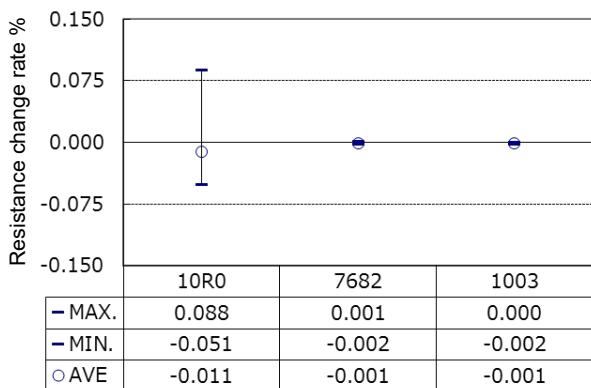


Low-temperature operation n=10

Condition: -55°C-1Hr→rated voltage for 45min

Limit:  $\pm (0.15\%+0.01\Omega)$

J2050/J401-1005

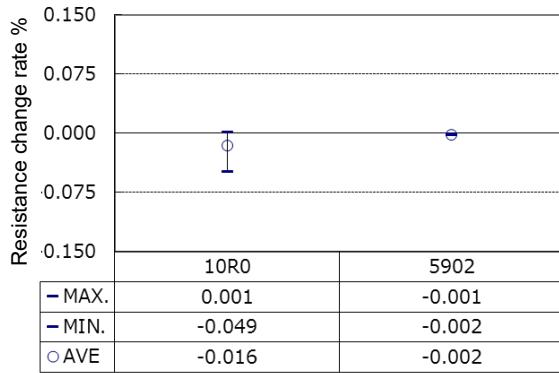


Low-temperature operation n=15

Condition: -55°C-1Hr→rated voltage for 45min

Limit:  $\pm (0.15\%+0.01\Omega)$

J2050/J401-1608

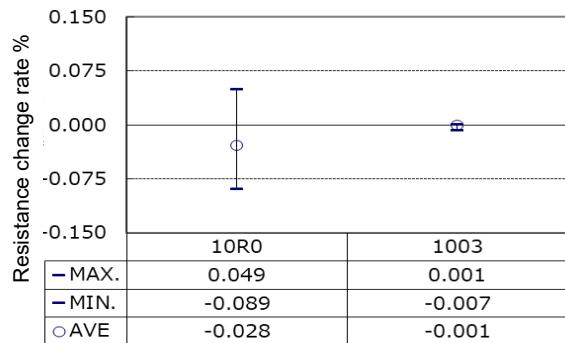


Low-temperature operation n=15

Condition: -55°C-1Hr→rated voltage for 45min

Limit:  $\pm (0.15\%+0.01\Omega)$

J2050/J401-2012

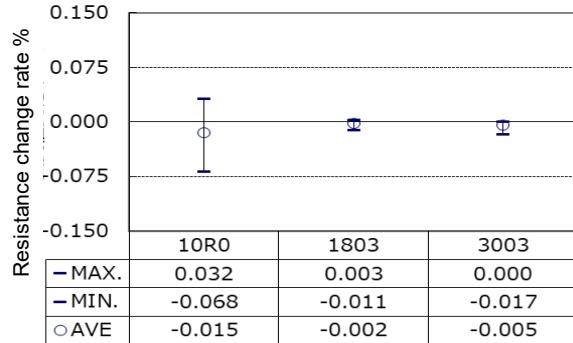


Low-temperature operation n=10

Condition: -55°C-1Hr→rated voltage for 45min

Limit:  $\pm (0.15\%+0.01\Omega)$

J2050/J401-3216

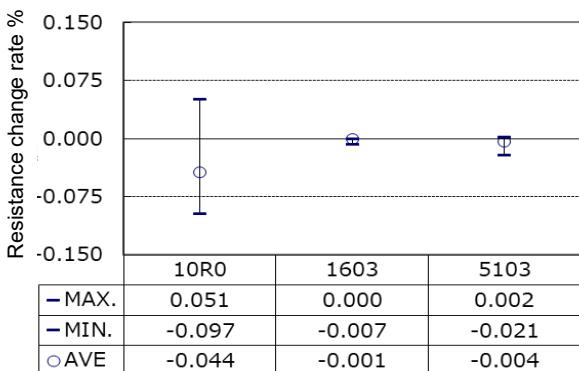


Low-temperature operation n=10

Condition: -55°C-1Hr→rated voltage for 45min

Limit:  $\pm (0.15\%+0.01\Omega)$

J2050/J401-3225



**Accelerated life test**

In this requalification test, life test was performed using acceleration test in which the life is accelerated by the ambient temperature. The calculation for acceleration factor and the test results are as follows:

(Calculation for acceleration factor due to temperature increase)

Based on the environment condition at 85 °C specified in paragraph J.3.10.1, Appendix J of JAXA-QTS-2050, the temperature acceleration factor for the environment at 125 °C calculated by using Arrhenius model was 12.26 and thus the testing duration calculated for 125°C was 326 hours while the testing duration for the above test method was 4000 hours.

Based on the above results, the actual requalification test was performed for 1000 hours.

**Arrhenius equation**

$$A_T = e \left[ \left( \frac{EA}{k} \right) \times \left( \frac{1}{T_1} - \frac{1}{T_2} \right) \right]$$

$$= \underline{12.26}$$

EA=Activation energy: 0.77

K=Boltzmann constant=8.617 x 10<sup>-5</sup>eV/K

T1=Temperature at reference state (85°C)

T2=Temperature at test (125°C)

At=Temperature acceleration factor

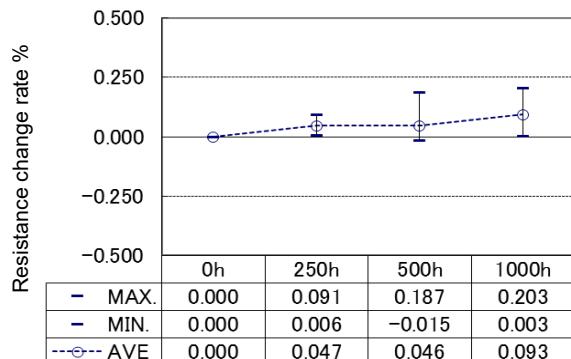
$$\underline{e \doteq 2.72}$$

Life (Acceleration test) n=77

Condition: 125°C-rated voltage, 1000H

Limit: ± (0.50%+0.01Ω)

J2050/J401-1005 (10.0Ω)

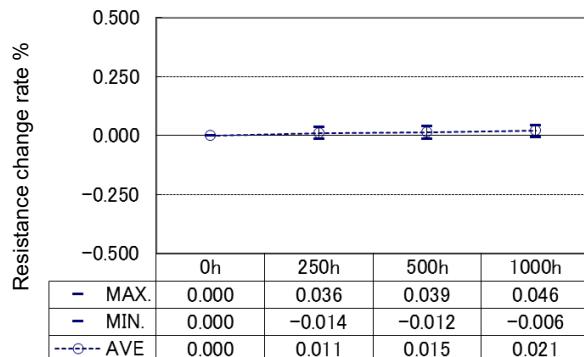


Life (Acceleration test) n=77

Condition: 125°C-rated voltage, 1000H

Limit: ± (0.50%+0.01Ω)

J2050/J401-1005 (76.8kΩ)

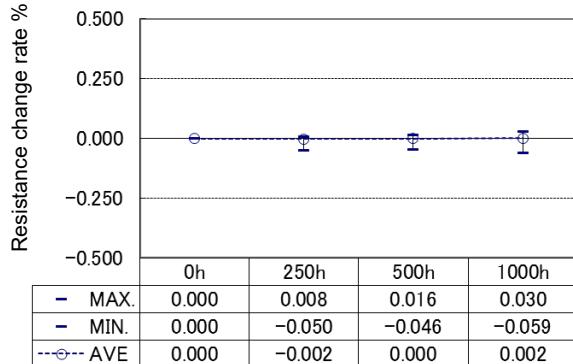


Life (Acceleration test) n=77

Condition: 125°C-rated voltage, 1000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-1005 (100k $\Omega$ )

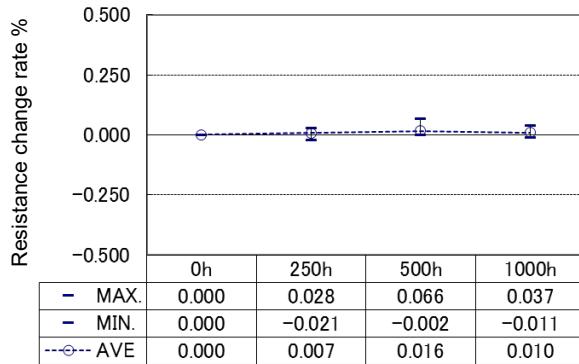


Life (Acceleration test) n=115

Condition: 125°C-rated voltage, 1000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-1608 (10.0 $\Omega$ )

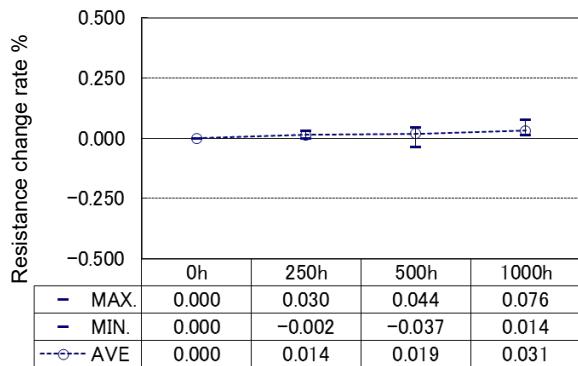


Life (Acceleration test) n=116

Condition: 125°C-rated voltage, 1000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-1608 (59.0k $\Omega$ )

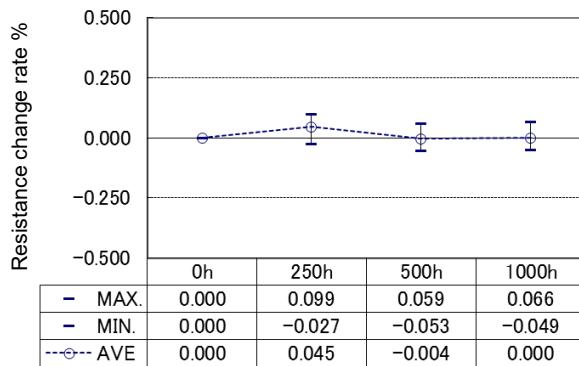


Life (Acceleration test) n=115

Condition: 125°C-rated voltage, 1000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-2012 (10.0 $\Omega$ )

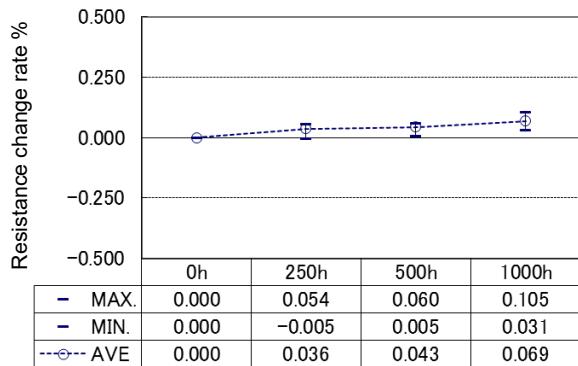


Life (Acceleration test) n=116

Condition: 125°C-rated voltage, 1000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-2012 (100k $\Omega$ )

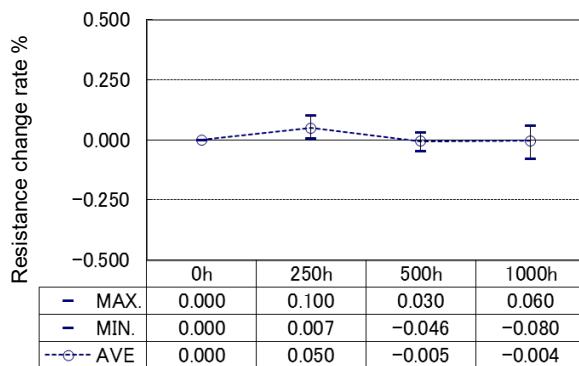


Life (Acceleration test) n=77

Condition: 125°C-rated voltage, 1000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-3216 (10.0 $\Omega$ )

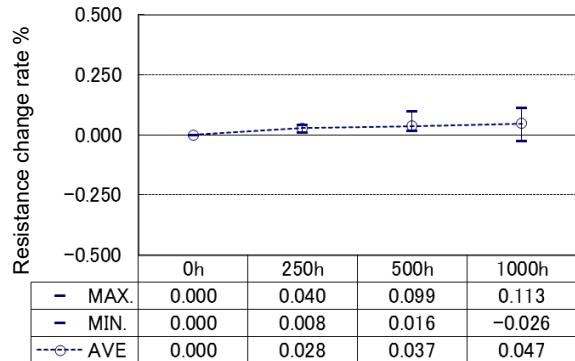


Life (Acceleration test) n=77

Condition: 125°C-rated voltage, 1000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-3216 (180k $\Omega$ )

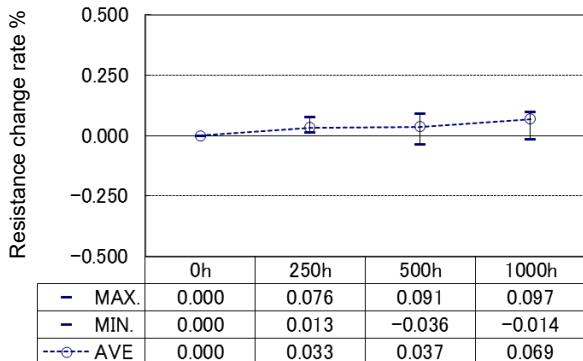


Life (Acceleration test) n=77

Condition: 125°C-rated voltage, 1000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-3216 (300k $\Omega$ )

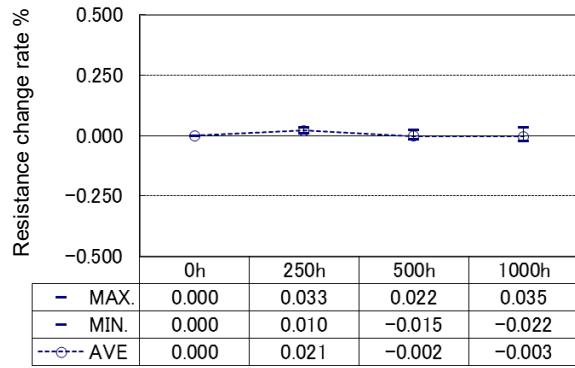


Life (Acceleration test) n=77

Condition: 125°C-rated voltage, 1000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-3225 (10.0 $\Omega$ )

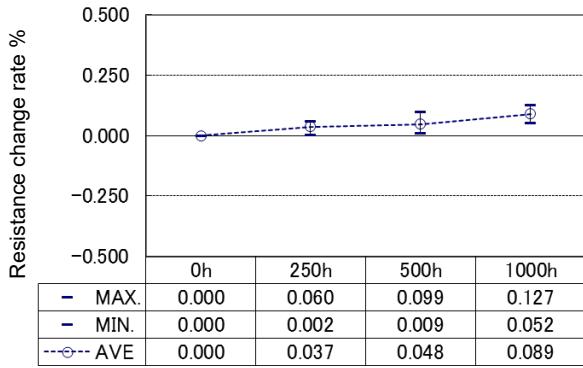


Life (Acceleration test) n=77

Condition: 125°C-rated voltage, 1000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-3225 (160k $\Omega$ )

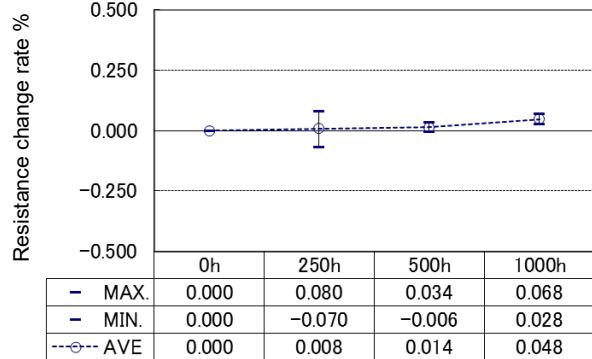


Life (Acceleration test) n=77

Condition: 125°C-rated voltage, 1000H

Limit:  $\pm (0.50\% + 0.01\Omega)$

J2050/J401-3225 (510k $\Omega$ )



## 6. RELIABILITY

### 6.1 Failure Rate

#### 6.1.1 Failure Rate of Qualified Parts

The failure rate of this product was calculated based on the whole data from life test (4000Hr) performed as a part of qualification test.

Part name	Average rate of change <sup>(1)</sup>	Failure rate <sup>(2)</sup>	Failure rate level <sup>(3)</sup>
J2050/J401-XXXX	0.03%	0.020%/1000h	P

- (1) Average resistance change rate of 4,000 hour life test performed on 13 items (1157 samples in total).
- (2) Failure rate ( $\lambda$ ) = 0.917/total test time @reliability level :60% @85°C
- (3) Referenced to the failure rate specified in JIS C 5003.

#### 6.1.2 Failure Rate Field Data of General-Purpose Parts (reference)

The filed failure rate of general-purpose resistor (RN73) which has identical structure and design to this product is as follows.

Part name	No. of failure	Total component hour <sup>(1)</sup>	Failure rare <sup>(2)</sup>
RN73 series	0	$21.494 \times 10^{12}$	0.000043 fit

- (1) Delivery record: Calculated from the total number of deliveries since 2005. Operating time was calculated on assumption that the product operated 4 hours per day and 23 days per month for 5 years.
- (2) When the number of failure is 0, the failure rate is calculated by dividing 0.917 by total component hour in accordance with JIS C 5003.

### 6.2 Possible Failure Modes

Failure mode	Occurrence rate
Open-circuit and resistance increase	80%
Short-circuit and resistance decrease	20%

## 7. STORAGE CONDITIONS

Resistors shall be kept in delivery package for storage. Storage period shall be within 12 months at 5 to 35°C/35 to 75%RH. Use caution to avoid dew condensation or exposure to harmful gas (hydrogen sulfide, nitrous acid gas, hydrogen chloride etc.) and dust as it may degrade the solderability of resistors.

## 8. NOTES

When heat-resistant masking tape is attached to and peeled off of the chip resistor, the upper electrode may detach. It is confirmed that the bonding strength of the tape adhesive increases

due to the heat during mounting the product in particular. Therefore, refrain from using heat-resistant masking tape, or if such tapes are needed to be used, use a method in which the tape adhesive does not come into direct contact with the product.

After mounting the product, the cleaning methods, which put stress on the product, such as brushing and high pressure shower should be avoided due to possible detachment of the upper electrode. However, if such cleaning methods are necessary, they should be evaluated prior to use.

## 9. OTHERS

The contact information on this data sheet is as follows:

Manufacturer: SANADA KOA Corporation

Address: 4-5 Yazaki-cho, Fuchu, Tokyo, 183-0025, Japan

Telephone: +81-42-364-8321

Fax: +81-42-366-0411

**Appended Table: Nominal Resistance Range**

Style	Temperature characteristics ( $\times 10^{-6} / ^\circ\text{C}$ )	Nominal resistance range ( $\Omega$ )		
		B ( $\pm 0.1\%$ )	D ( $\pm 0.5\%$ )	F ( $\pm 1.0\%$ )
1005	Y ( $\pm 10$ )	100 to 10k	100 to 10k	100 to 10k
	E ( $\pm 25$ )	100 to 100k	51 to 100k	51 to 100k
	H ( $\pm 50$ )	100 to 100k	10 to 100k	10 to 100k
1608	A ( $\pm 5$ )	100 to 47k	—	—
	Y ( $\pm 10$ )	100 to 59k	100 to 59k	100 to 59k
	E ( $\pm 25$ )	15 to 59k	10 to 59k	10 to 59k
	H ( $\pm 50$ )	15 to 59k	10 to 59k	10 to 59k
2012	A ( $\pm 5$ )	100 to 100k	—	—
	Y ( $\pm 10$ )	100 to 100k	100 to 100k	100 to 100k
	E ( $\pm 25$ )	15 to 100k	10 to 100k	10 to 100k
	H ( $\pm 50$ )	15 to 100k	10 to 100k	10 to 100k
3216	A ( $\pm 5$ )	100 to 300k	—	—
	Y ( $\pm 10$ )	100 to 300k	100 to 300k	100 to 300k
	E ( $\pm 25$ )	15 to 300k	10 to 300k	10 to 300k
	H ( $\pm 50$ )	15 to 300k	10 to 300k	10 to 300k
3225	Y ( $\pm 10$ )	100 to 510k	100 to 510k	100 to 510k
	E ( $\pm 25$ )	15 to 510k	10 to 510k	10 to 510k
	H ( $\pm 50$ )	15 to 510k	10 to 510k	10 to 510k